



CONNECT WITH RELIABILITY

## NEWS RELEASE

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### **Quatech Launches 802.11b/g Wireless Networking Products for OEMs**

***Quatech Airborne™ and AirborneDirect™ embedded and external products  
build secure wireless capabilities into machine-to-machine devices***

**Hudson, OH, May 8, 2006** – QuaTech Inc., a wholly-owned subsidiary of DPAC Technologies Corp. (OTCBB: DPAC) and a leader in high performance device networking solutions, announced the launch of the next generation of its entire family of Airborne™ 802.11 embedded wireless modules and AirborneDirect™ 802.11 external wireless networking products for OEM machine-to-machine (M2M) applications.

The new line of products features the higher connection rates of the 802.11g standards, plug-n-play compatibility with Quatech's existing 802.11b product line, advanced security features and extended environmental specifications. They are also fully compliant with RoHS standards.

"This new family of 802.11b/g products extends our leadership position in 802.11 wireless embedded networking that DPAC began with the industry's first module in 2003," said Steve Runkel, president and CEO of Quatech. "We're excited about the opportunity to bring the additional benefits of the 802.11g standard to our customers and partners. We see a demand for the performance and security features enabled by these new products, and we believe our customers will continue to experience the industry's best combination of cost, ease-of-deployment, performance and throughput."

Over the past three years, the Airborne and AirborneDirect products have been integrated into a wide variety of M2M communications applications, from transportation and industrial automation to medical diagnostics and warehouse/logistics. The product family is designed to be quickly and easily integrated by OEMs to build secure 802.11 wireless capabilities into virtually any M2M device. The product line offers features such as extended environmental specifications (operating temperature range of -40°C to +85°C), advanced Security protocols (WEP—64 & 128 bit, WPA, 802.1x-LEAP, integrated AES/CCMP), RoHS compliance, and Regulatory pre-certifications across the globe (like U.S. Federal Communications Commission certification) allowing OEMs to leverage Quatech's license grant and bypass most or all regulatory testing.

The Quatech Airborne and AirborneDirect products that feature the 802.11b/g functionality are:

**Airborne™ 802.11b/g embedded Wireless Device Server Module** — This compact drop-in module is interoperable with 802.11b and 802.11g access points and provides a cost-efficient infrastructure for a LAN or Internet connection. This module's built-in TCP/IP stack, Real-Time Operating System and application firmware permit instant connectivity to a LAN or the Internet,

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with no device driver or host processor firmware development required. The module offers power management capabilities, integrated web server, general purpose I/O, and embedded interface support for UART, I<sup>2</sup>C, SPI, and industry-standard RS-232/422/485 protocols.

**Airborne™ 802.11b/g embedded Wireless Ethernet Bridge Module** — This embedded module features an industry-standard interface to OEMs seeking to add wireless 802.11b/g connectivity to products with a built-in Ethernet interface. The module includes a built-in web server that provides full configuration capabilities and embedded command line interface.

**AirborneDirect™ 802.11b/g external Wireless Device Server** — A multi-protocol serial-to-802.11b/g device server, this external product simplifies the process of adding wireless connectivity to existing products with existing serial interface. The product supports industry-standard RS-232/422/485 interfaces, and incorporates a specific command set for OEMs who need to add 802.11b/g connectivity to products with a built-in serial interface.

**AirborneDirect™ 802.11b/g external Wireless Ethernet Bridge** — This external unit creates a connection between an 802.11b/g wireless LAN and a device with an Ethernet port. The product can be configured through a built-in web server or from the embedded command line interface.

Quatech Airborne and AirborneDirect 802.11b/g product shipments will begin in June 2006. For more information, please visit: <http://www.quatech.com/products/embedded.php>.

Mandated by the European Parliament and Council of the European Union, RoHS (Restriction on Hazardous Substances) requires that manufacturers reduce the usage of certain substances in electrical and electronic equipment by July 2006.

#### **About Quatech and DPAC Technologies**

Quatech high performance device networking & connectivity solutions help companies improve their bottom line performance. Quatech enables reliable machine-to-machine (M2M) communications via secure 802.11 wireless or traditional wired networks with industrial grade (hardened) embedded radios, modules, boards and external device servers and bridges. For local and mobile connections, Quatech serial adapters provide secure connectivity and port expansion via many interface options. Satisfied customers rely on our unique combination of performance and support to improve bottom line performance through real-time remote monitoring & control, streamlined systems and lower total cost of ownership (TCO). Quatech markets its products through a global network of distributors, resellers, systems integrators and original equipment manufacturers (OEMs). Founded in 1983, Quatech is headquartered in Hudson, Ohio, and merged with DPAC Technologies, Inc. in February 2006. [www.quatech.com](http://www.quatech.com).

DPAC Technologies (OTCBB: DPAC) provides embedded wireless networking products for machine-to-machine communication applications. DPAC's Airborne™ and AirborneDirect™ wireless products are used by major OEMs in the transportation, instrumentation and industrial control, homeland security, medical diagnostics and logistics markets to provide mobile short range data collection and control. Information concerning the combined company under parent company DPAC Technologies Corp. is filed with the SEC and is available on the SEC website, [www.sec.gov](http://www.sec.gov). DPAC Technologies Corp. is based in Hudson, OH. [www.dpactech.com](http://www.dpactech.com).

#### **Forward-Looking Statements**

This press release includes forward-looking statements. You can identify these statements by their forward-looking words such as "may," "will," "expect," "anticipate," "believe," "guidance," "estimate," "intend," "predict," and "continue" or similar words or any connection with any discussion of future events or circumstances or of management's current estimates or beliefs. Forward-looking statements are subject to risks and uncertainties, and therefore results may differ materially from those set forth in those statements. More information about the risks and challenges faced by DPAC Technologies Corp. is contained in the Securities and Exchange Commission filings made by the Company on Form S-4, 10-K, 10-Q and 8-K. DPAC Technologies Corp. specifically disclaims any obligation to update or revise any forward-looking statements whether as a result of new information, future developments or otherwise.

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